

林亦波

University of Texas at Austin, Austin, TX 78712 ◇ 德克萨斯大学奥斯汀分校

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博士 ◇ 电子工程系

研究方向

针对于超大规模集成电路设计自动化和新兴技术的建模和优化、深度学习及其应用、硬件安全

教育经历

德克萨斯大学奥斯汀分校

2013 年 8 月 – 2018 年 5 月

博士学位, 电子工程系

指导老师: David Z. Pan

博士毕业论文: “Bridging Design and Manufacturing Gap through Machine Learning and Machine-Generated Layout”

(学积分 3.96/4.0)

上海交通大学

2009 年 9 月 – 2013 年 6 月

学士学位, 微电子学院

(学积分 91.17/100)

(排名 1/60)

工作经历

德克萨斯大学奥斯汀分校

2018 年 7 月 – 2019 年 6 月

博后

日本东芝存储

2017 年 5 月 – 2017 年 8 月

实习

Memory lithography group

比利时微电子研究中心 (IMEC)

2016 年 9 月 – 2016 年 11 月

实习

Design technology co-optimization for emerging lithography options

香港中文大学

2016 年 6 月 – 2016 年 8 月

实习

Quantum computing

铿腾半导体

2015 年 5 月 – 2015 年 8 月

实习

Routability driven detailed placement

甲骨文股份有限公司

2014 年 5 月 – 2014 年 8 月

实习

Incremental timing driven detailed placement

授课经历

客座讲座	EE382M: VLSI Physical Design Automation	2017 年秋
研究生课程助教	EE382M: VLSI I	2014 年秋

出版物

书籍章节

- [B1] **Yibo Lin** and David Z. Pan, “Machine Learning in Physical Verification, Mask Synthesis, and Physical Design”, Machine Learning in VLSI Computer-Aided Design, Springer, 2018, edited by Abe Elfedel, Duane Boning and Xin Li. (**Invited Book Chapter**)(to be published)

期刊论文

- [J13] **Yibo Lin**, Meng Li, Yuki Watanabe, Taiki Kimura, Tetsuaki Matsunawa, Shigeki Nojima and David Z. Pan, “[Data Efficient Lithography Modeling with Transfer Learning and Active Data Selection](#)”, IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems (TCAD), 2019. (accepted)
- [J12] Qi Sun, **Yibo Lin**, Iris Hui-Ru Jiang, Bei Yu and David Z Pan, “[OpenMPL: An Open Source Layout Decomposer](#)”, arXiv preprint arXiv:1809.07554, 2018.
- [J11] **Yibo Lin**, Bei Yu, Meng Li and David Z. Pan, “[Layout Synthesis for Topological Quantum Circuits with 1D and 2D Architectures](#)”, IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems (TCAD), Aug, 2018.
- [J10] Xiaoqing Xu, **Yibo Lin**, Meng Li, Tetsuaki Matsunawa, Shigeki Nojima, Chikaaki Kodama, Toshiya Kotani and David Z. Pan, “[Sub-Resolution Assist Feature Generation with Supervised Data Learning](#)”, IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems (TCAD), Jun, 2018.
- [J9] **Yibo Lin**, Bei Yu, Xiaoqing Xu, Jih-Rong Gao, Natarajan Viswanathan, Wen-Hao Liu, Zhuo Li, Charles J Alpert and David Z. Pan, “[MrDP: Multiple-row detailed placement of heterogeneous-sized cells for advanced nodes](#)”, IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems (TCAD), Jun, 2018.
- [J8] Wuxi Li, **Yibo Lin**, Meng Li, Shounak Dhar and David Z. Pan, “[UTPlaceF 2.0: A High-Performance Clock-Aware FPGA Placement Engine](#)”, ACM Transactions on Design Automation of Electronic Systems (TODAES), Jun, 2018.
- [J7] **Yibo Lin**, Bei Yu and David Z. Pan, “[High performance dummy fill insertion with coupling and uniformity constraints](#)”, IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems (TCAD), Sep, 2017.
- [J6] **Yibo Lin**, Bei Yu, Biying Xu and David Z. Pan, “[Triple patterning aware detailed placement toward zero cross-row middle-of-line conflict](#)”, IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems (TCAD), Jul, 2017.
- [J5] Xiaoqing Xu, **Yibo Lin**, Meng Li, Jiaojiao Ou, B. Cline and D. Z. Pan, “[Redundant local-Loop insertion for unidirectional routing](#)”, IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems (TCAD), Jul, 2017.

- [J4] **Yibo Lin**, Bei Yu, Yi Zou, Zhuo Li, Charles J Alpert and David Z. Pan, “[Stitch aware detailed placement for multiple e-beam lithography](#)”, Integration, the VLSI Journal, Jun, 2017. (**Best Paper Award**)
- [J3] **Yibo Lin**, Xiaoqing Xu, Bei Yu, Ross Baldick and David Z. Pan, “[Triple/quadruple patterning layout decomposition via linear programming and iterative rounding](#)”, Journal of Micro/Nanolithography, MEMS, and MOEMS (JM3), Jun, 2017.
- [J2] Bei Yu, Xiaoqing Xu, Subhendu Roy, **Yibo Lin**, Jiaojiao Ou and David Z. Pan, “[Design for manufacturability and reliability in extreme-scaling VLSI](#)”, Science China Information Sciences, 2016. (**Invited paper**)
- [J1] Bei Yu, Xiaoqing Xu, Jhih-Rong Gao, **Yibo Lin**, Zhuo Li, Charles Alpert and David Z. Pan, “[Methodology for standard cell compliance and detailed placement for triple patterning lithography](#)”, IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems (TCAD), May, 2015.

会议论文

- [C21] Wei Ye, Mohamed Baker Alawieh, Meng Li, **Yibo Lin** and David Z. Pan, “Litho-GPA: Gaussian Process Assurance for Lithography Hotspot Detection”, IEEE/ACM Proceedings Design, Automation and Test in Europe (DATE), Florence, Italy, Mar 25-29, 2019. (accepted)
- [C20] Ying Chen, **Yibo Lin**, Tianyang Gai, Yajuan Su, Yayi Wei and David Z. Pan, “Semi-Supervised Hotspot Detection with Self-Paced Multi-Task Learning”, IEEE/ACM Asia and South Pacific Design Automation Conference (ASPDAC), Tokyo, Japan, Jan 21-24, 2019. (accepted)
- [C19] Wei Ye, Mohamed Baker Alawieh, **Yibo Lin** and David Z. Pan, “Tackling Signal Electromigration with Learning-Based Detection and Multistage Mitigation”, IEEE/ACM Asia and South Pacific Design Automation Conference (ASPDAC), Tokyo, Japan, Jan 21-24, 2019. (accepted)
- [C18] Wei Ye, **Yibo Lin**, Meng Li, Qiang Liu and David Z. Pan, “LithoROC: Lithography Hotspot Detection with Explicit ROC Optimization”, IEEE/ACM Asia and South Pacific Design Automation Conference (ASPDAC), Tokyo, Japan, Jan 21-24, 2019. (**Invited paper**)
- [C17] **Yibo Lin**, Mohamed Baker Alawieh, Wei Ye and David Z. Pan, “Machine Learning for Yield Learning and Optimization”, IEEE International Test Conference (ITC), Phoenix, Arizona, Oct, 2018. (**Invited paper**)
- [C16] Jiong Zhang, **Yibo Lin**, Zhao Song and Inderjit S Dhillon, “[Learning Long Term Dependencies via Fourier Recurrent Units](#)”, International Conference on Machine Learning (ICML), Stockholm, Sweden, Jun 10-15, 2018.
- [C15] **Yibo Lin**, Yuki Watanabe, Taiki Kimura, Tetsuaki Matsunawa, Shigeki Nojima, Meng Li and David Z. Pan, “[Data Efficient Lithography Modeling with Residual Neural Networks and Transfer Learning](#)”, ACM International Symposium on Physical Design (ISPD), Monterey, CA, Mar 25-28, 2018.
- [C14] Meng Li, Bei Yu, **Yibo Lin**, Xiaoqing Xu, Wuxi Li and David Z. Pan, “[A Practical Split Manufacturing Framework for Trojan Prevention via Simultaneous Wire Lifting and Cell Insertion](#)”, IEEE/ACM Asia and South Pacific Design Automation Conference (ASPDAC), Jeju, Korea, Jan 22-25, 2018.
- [C13] **Yibo Lin**, Peter Debacker, Darko Trivkovic, Ryoung-han Kim, Praveen Raghavan and David Z. Pan,

- “Patterning Aware Design Optimization of Selective Etching in N5 and Beyond”, IEEE International Conference on Computer Design (ICCD), Boston, MA, Nov 5-8, 2017.
- [C12] **Yibo Lin**, Xiaoqing Xu, Jiaojiao Ou and David Z Pan, “Machine learning for mask/wafer hotspot detection and mask synthesis”, Photomask Technology, Oct 16, 2017. (**Invited paper**)
- [C11] Wei Ye, **Yibo Lin**, Xiaoqing Xu, Wuxi Li, Yiwei Fu, Yongsheng Sun, Canhui Zhan and David Z. Pan, “Placement Mitigation Techniques for Power Grid Electromigration”, IEEE International Symposium on Low Power Electronics and Design (ISLPED), Taipei, Jul 24-26, 2017.
- [C10] Xiaoqing Xu, **Yibo Lin**, Vinicius Livramento and David Z. Pan, “Concurrent Pin Access Optimization for Unidirectional Routing”, ACM/IEEE Design Automation Conference (DAC), Austin, TX, Jun 18-22, 2017.
- [C9] Jiaojiao Ou, Bei Yu, Xiaoqing Xu, Joydeep Mitra, **Yibo Lin** and David Z. Pan, “DSAR: DSA aware routing with simultaneous DSA guiding pattern and double patterning assignment”, ACM International Symposium on Physical Design (ISPD), Portland, OR, Mar 19-22, 2017.
- [C8] **Yibo Lin**, Bei Yu, Xiaoqing Xu, Jih-Rong Gao, Natarajan Viswanathan, Wen-Hao Liu, Zhuo Li, Charles J Alpert and David Z. Pan, “MrDP: Multiple-row detailed placement of heterogeneous-sized cells for advanced nodes”, IEEE/ACM International Conference on Computer-Aided Design (ICCAD), Austin, TX, Nov 7-10, 2016.
- [C7] Yudong Tao, Changhao Yan, **Yibo Lin**, Sheng-Guo Wang, David Z. Pan and Xuan Zeng, “A novel unified dummy fill insertion framework with SQP-based optimization method”, IEEE/ACM International Conference on Computer-Aided Design (ICCAD), Austin, TX, Nov 7-10, 2016.
- [C6] **Yibo Lin**, Bei Yu and David Z. Pan, “Detailed placement in advanced technology nodes: a survey”, IEEE International Conference on Solid-State and Integrated Circuit Technology (ICSICT), Hangzhou, China, Oct 25-28, 2016. (**Invited paper**)
- [C5] **Yibo Lin**, Xiaoqing Xu, Bei Yu, Ross Baldick and David Z. Pan, “Triple/quadruple patterning layout decomposition via novel linear programming and iterative rounding”, Proceedings of SPIE, San Jose, CA, Feb 21-25, 2016. (**Best Student Paper Award**)
- [C4] **Yibo Lin**, Bei Yu, Yi Zou, Zhuo Li, Charles J Alpert and David Z. Pan, “Stitch aware detailed placement for multiple e-beam lithography”, IEEE/ACM Asia and South Pacific Design Automation Conference (ASPDAC), Macau, China, Jan 25-28, 2016.
- [C3] **Yibo Lin**, Bei Yu, Biying Xu and David Z. Pan, “Triple patterning aware detailed placement toward zero cross-row middle-of-line conflict”, IEEE/ACM International Conference on Computer-Aided Design (ICCAD), Austin, TX, Nov 2-6, 2015.
- [C2] **Yibo Lin**, Bei Yu and David Z. Pan, “High performance dummy fill insertion with coupling and uniformity constraints”, ACM/IEEE Design Automation Conference (DAC), San Francisco, CA, Jun 7-11, 2015.
- [C1] David Z. Pan, Lars Liebmann, Bei Yu, Xiaoqing Xu and **Yibo Lin**, “Pushing multiple patterning in sub-10nm: are we ready?”, ACM/IEEE Design Automation Conference (DAC), San Francisco, CA, Jun 7-11, 2015. (**Invited Paper**)

相关课程

• EE382M: VLSI I	<i>Prof. Michael Orshansky</i>
• EE382N: Computer Architecture	<i>Prof. Aater Suleman</i>
• EE382V: Optimization Issues in VLSI CAD	<i>Prof. David Pan</i>
• EE382M: VLSI II	<i>Prof. Jacob Abraham</i>
• EE380L: Engineer Programming Languages	<i>Prof. Craig Chase</i>
• EE382V: Nanometer Scale IC Design	<i>Prof. Michael Orshansky</i>
• EE382V: VLSI Physical Design Automation	<i>Prof. David Pan</i>
• EE381V: Advanced Algorithms	<i>Prof. Evdokia Nikolova</i>
• EE382V: Advanced Programming Tools	<i>Prof. Aziz Adnan</i>
• EE380N: Optimization in Engineering Systems	<i>Prof. Ross Baldick</i>
• CS383C: Numerical Analysis: Linear Algebra	<i>Prof. Robert van de Geijn</i>

技能

编程语言

C/C++, Python, Verilog

网页制作

HTML5, JavaScript/jQuery

设计自动化工具

Cadence Virtuoso, Synopsys Design Compiler, Synopsys IC Compiler

奖项及荣誉

首届最佳论文	Integration, the VLSI Journal	2018 年
Graduate Continuing Fellowship	德克萨斯大学奥斯汀分校	2017 年
Franco Cerrina Memorial 最佳学生论文	SPIE	2016 年
A. Richard Newton Young Student Fellow	DAC	2014 年
国家奖学金	上海交通大学	2012 年
三星奖学金	上海交通大学	2011 年
二等奖学金	上海交通大学	2010 年